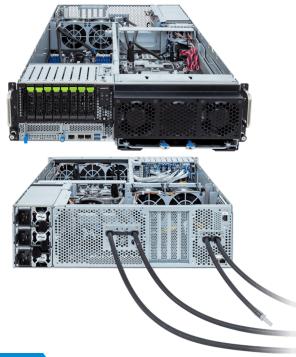
G363-ZR0-LAX4

HPC/AI Server - 3U DP HGX[™] H200 4-GPU DLC





Key Features

- Liquid-cooled NVIDIA HGX[™] H200 4-GPU
- CPU+GPU direct liquid cooling solution
- 4th-generation NVIDIA NVLink[™] 900GB/s
- Dual AMD EPYC[™] 9005/9004 Series Processors
- 12-Channel DDR5 RDIMM, 24 x DIMMs
- Dual ROM Architecture
- 2 x 10Gb/s LAN ports via Broadcom® BCM57416
- 2 x 1Gb/s LAN ports via Intel® I350-AM2
- 4 x 2.5" Gen5 NVMe/SATA/SAS-4 hot-swap bays
- 4 x 2.5" Gen5 NVMe hot-swap bays
- 1 x M.2 slot with PCIe Gen4 x4 interface
- 6 x LP PCIe Gen5 x16 slots
- 2+1 3000W 80 PLUS Titanium redundant power supplies

Applications

Al Platform, Al Training Server, Al Inference Server, High-Performance Computing Server...

Specification

Dimensions	3U (W448 x H131 x D850.2 mm)	RAID	Require RAID add-in cards
Motherboard	MZ83-HD1	Modular GPU	Liquid-cooled NVIDIA HGX^{TM} H200 with $4 \times \operatorname{SXM}$ GPUs
CPU	AMD EPYC [™] 9005 Series Processors AMD EPYC [™] 9004 Series Processors Dual processor, cTDP up to 400W ^[1] ^[1] The ambient temperature is limited to 30°C when NVIDIA® BlueField®-3 DPUs are installed.	PCIe Expansion Slots	6 x LP PCIe Gen5 x16
		I/O Ports	Front: 2 x USB 3.2 Gen1, 1 x Mini-DP, 2 x RJ45, 1 x MLAN (default) Rear: 2 x RJ45, 1 x MLAN
OS Compatibility	OS Support List	Backplane Board TPM	PCIe Gen5 x4 or SATA 6Gb/s or SAS-4 24Gb/s
Socket	2 x LGA 6096 (Socket SP5)		
Chipset	System on Chip		1 x TPM header (SPI), Optional TPM2.0 kit: CTM010 2+1 3000W 80 PLUS Titanium redundant power supplies AC Input: 115-240V
Memory	12-Channel DDR5 RDIMM, 24 x DIMMs [EPYC 9005] Up to 6400 MT/s [EPYC 9004] Up to 4800 MT/s	Power Supply	
			*The system power supply requires C19 power cord.
LAN	Front: 2 x 1Gb/s LAN (1 x Intel [®] I350-AM2), Support NCSI 1 x 10/100/1000 Mbps Management LAN Rear: 2 x 10Gb/s LAN (1 x Broadcom [®] BCM57416), Support NCSI 1 x 10/100/1000 Mbps Management LAN	System Management	ASPEED® AST2600 Baseboard Management Controller GIGABYTE Management Console web interface
		System Fans	4 x 80x80x80mm
		Operating Properties	Operating: 10°C to 35°C, 8% to 80% (non-condensing) Non-operating: -40°C to 60°C, 20% to 95% (non-condensing)
Video	Integrated in ASPEED [®] AST2600 - 1 x Mini-DP	Packaging Content	1 x G363-ZR0-LAX4 1 x Mini-DP to D-Sub cable
Storage	Front hot-swap: 4 x 2.5" Gen5 NVMe/SATA/SAS-4 [1] 4 x 2.5" Gen5 NVMe Internal M.2: 1 x M.2 (2280/22110), PCIe Gen4 x4		1 x L-shape Rail kit
		Ordering Part Numbers	6NG363ZR0DR000LCX4*
	[1] SAS card is required to support SAS drives.		





* All specifications are subject to change without notice. Please visit our website for the latest information.

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